



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40℃ to +105℃

Contact Material:Copper Alloy

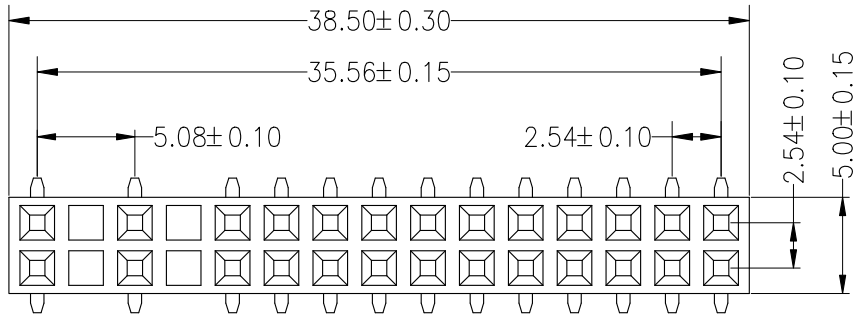
Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

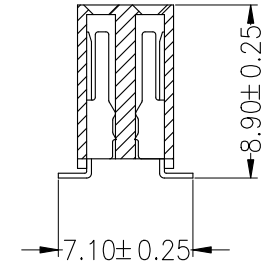
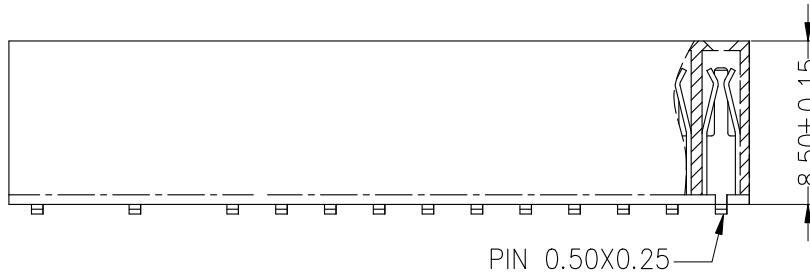
Standard: PA6T

Max.Processing Temp: 260℃±5℃ 5S

客户料号：706068884



注：缺第3.4.7.8P



Ordering Information

2285 02 10 X N XX M U X XX

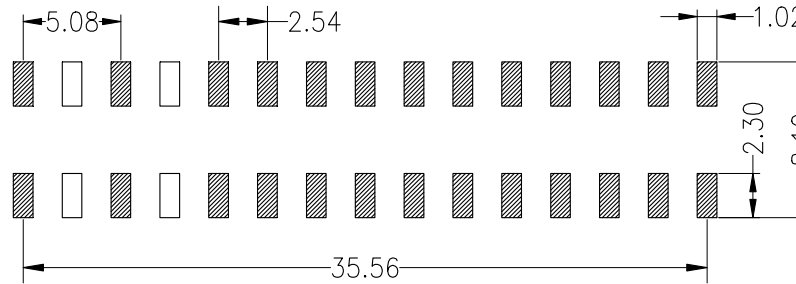
No. of Pins
Per Row
10P

Insulator Material
Option
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating
G1:Gold Flash
G2:1.5U" Gold
G3:2U" Gold
G4:3U" Gold
G5:5U" Gold
G6:10U" Gold
G7:15U" Gold
G8:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
O=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap

code stream
01~99



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

A					OPERATION		DRAW	RICH LIN	23.02.13	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5992	
					X.X	±0.30				UNIT	mm		
					X.XX	±0.20	CHECK			SIZE	A4	PART NO.	22850215XNXXMUXXX
					X.XXX	±0.10				SHEET	1/1		
	REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL	APPROVE		PROJ.		TITLE:	2.54PF H8.5mm 2x15pin SMT W5.0